



BW20-07S Specification

Version V1.0.0

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Document resume

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1. Product overview

BW20-07S is a dual-band Wi-Fi + BLE SoC module developed by Ai-Thinker based on RTL8711 series chips, which supports dual-band (2.4 GHz or 5 GHz) 802.11a/b/g/n WLAN protocol and Bluetooth 5.0 protocol. The BW20-07S integrates dual-core MCU, an ARM V8.1 (Cortex-M4F compatible) high-performance MCU with a maximum frequency of 330 MHz; an ARM V8M (Cortex-M0 compatible) low-power MCU.

The BW20-07S module has rich peripheral interfaces, including UART / GPIO / ADC / PWM / IIC / SPI / SDIO / IR / SWD / USB etc. It can be widely used in the Internet of Things (IoT), mobile devices, wearable electronic devices, smart home and other fields.

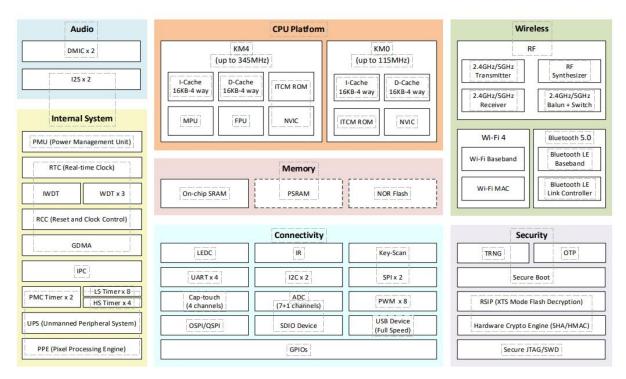


Figure 1 Chip Block Diagram



1.1. Characteristic

- Support for the 802.11a/b/g/n protocol
- Support for dual-frequency 2.4GHz or 5GHz
- Supports the HT 20 / HT 40 mode
- Support for Bluetooth 5.0
- Support for BLE Long Range
- The Bluetooth supports a high-power mode LE data length extension
- Support for link layer privacy
- Support for the hardware encryption engine
- Integrated dual-core MCU, up to 330 MHz
- Abundant interfaces, with 17 flexible IO ports
- Wi-Fi and Bluetooth share the same antenna
- Support secondary development, support programming in Linux and Windows environments
- Support for Arduino development



2. Main parameters

Table 1: Description of the main parameters

Model	BW20-07S
Package	SMD-23
Size	17*16*3.2(±0.2)MM
Antenna	IPEX connector (4th generation)
Frequency range	2400~2483.5MHz or 5180~5825MHz
Operating temperature	-40 °C~85 °C
Storage temperature	-40 °C~125 °C,<90%RH
Power supply	Voltage supply 3.0V~3.6V,typical value 3.3V, Current supply>500mA
Support interface	UART/GPIO/ADC/PWM/IIC/SPI/SDIO/IR/SWD/USB
Available IO	Default 17
UART rate	Default 115200bps
Bluetooth	BLE 5.0
SPI flash	Default 4MByte, Max support 16MByte

2.1. Static electricity requirement

The BW20-07S module is an electrostatically sensitive device and requires special ESD precautions. Usually, ESD protection devices should be added during use. The correct ESD handling and packaging methods must be used during the transportation, operation and use of the BW20-07S module. Do not touch the module with your hands or use a non-antistatic soldering iron for soldering to avoid damaging the module.



Figure 2 ESD Anti-static diagram



2.2. Electrical characteristics

Table 2 Electrical characteristics table

Parameters		Condition	Min.	Typical value	Max.	Unit
Volt	tage supply	3V3	3.0	3.3	3.6	V
	VIL	-	-	-	0.3*VDD	V
I/O	VIH	-	0.65*VDD	-	-	V
1/0	VOL	-	-	0.15*VDD	-	V
	VOH	-	-	0.85*VDD	-	V

2.3. Wi-Fi RF performance

Table 3 Wi-Fi RF performance

Description	Typical			Unit	
Frequency range	2400~2483.5 and 5180~5825			MHz	
	Output pov	ver			
Mode	Min. value	Typical	Max. value	Unit	
11a mode, PA output power	-	18	-	dBm	
11b mode, PA output power	-	19	-	dBm	
11g mode, PA output power	-	18	-	dBm	
11n mode, PA output power	-	17	-	dBm	
	Receiving sensitivity				
Mode	Min.value	Typical	Max. value	Unit	
11b, 1Mbps	-	-99	-	dBm	
11b, 11Mbps	-	-90	-	dBm	
11a/g, 6Mbps	-	-94	-	dBm	
11a/g, 54Mbps	-	-76	-	dBm	
HT20 (MCS0)	-	-93	-	dBm	
HT20 (MCS7)	-	-74	-	dBm	
HT40 (MCS0)	-	-91	-	dBm	
HT40 (MCS7)	-	-71	-	dBm	



2.4. BLE RF performance

Table 4 BLE RF performance

Description		Unit				
Frequency range	2400 ~ 2484MHz			MHz		
	Output power					
Rate mode	Min.value	Typical	Max.value	Unit		
1Mbps	-	15	-	dBm		
2Mbps	-	15	-	dBm		
Receiving sensitivity						
Rate mode	Min.value	Typical	Max.value	Unit		
1Mbps @30.8%PER	-	-98	-	dBm		
2Mbps @30.8%PER	-	-97	-	dBm		

2.5. Power consumption

The following power consumption data are based on the 3.3V power supply and the ambient temperature of 25° C.

- The POUT power for all transmission modes is measured at the antenna interface.
- All emission data were measured in the mode of continuous transmitting.

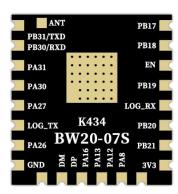
Table 5 Power consumption table

Mode	Min. value	Average value	Max. value	Unit
Tx 802.11b, 11Mbps, POUT=+22dBm	-	323	-	mA
Tx 802.11g, 54Mbps, POUT =+20dBm	-	98	-	mA
Tx 802.11n, MCS7, POUT =+20dBm	-	96	-	mA
Rx 802.11b	-	47	-	mA
Rx 802.11g	-	47	_	mA
Rx 802.11n	-	47	-	mA



3. Appearance size





Front Back

Figure 3 Appearance diagram (rendering diagram is for reference only, subject to physical objects)

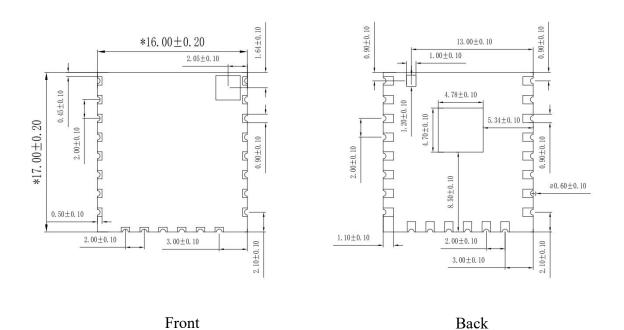


Figure 4 Size diagram



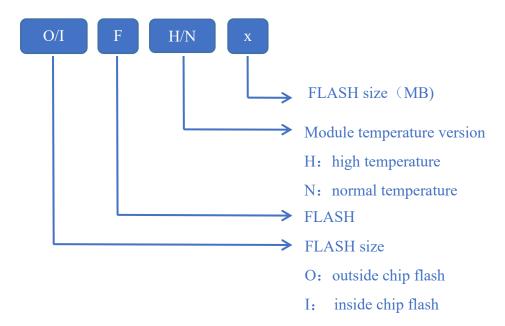
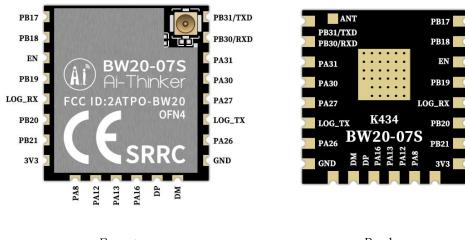


Figure 5 The screen cover information



4. Pin definition

BW20-07S is connected a total of 23 pins, as in the pin schematic diagram, and the definition of the pin function is shown in the following table.



Front Back

Figure 6 Pin diagram

Table 6 Pin function definition table

No	Name	Function description
1	PB17	TOUCH2_ADC2/SPI1_CS/SD_D3
2	PB18	TOUCH1_ADC1/SPI1_CLK/SD_CMD
3	EN	Chips enable pin and pull up effectively
4	PB19	TOUCH0_ADC0/SPI1_MOSI/SD_CLK
5	LOG_RX	UART_LOG_RXD, Firmware download RX pin
6	PB20	SPI1_MISO/SWD_CLK/SD_D0
7	PB21	SPI1_CS/SWD_DAT/SD_D1
8	3V3	$3.3V\ power\ supply\ (VDD)$, the external power supply output current is recommended in above $500mA$
9	PA8	PSRAM_DQ5/TIM8_TRIG
10	PA12	SPI0_CS/SD_D2/TIM9_TRIG
11	PA13	The default is not available and the IO is occupied by Flash inside the module. Please contact Ai-Thinker if need to use. SD_D2/external Flash this pin is NC



12	PA16	The default is not available and the IO is occupied by Flash inside the module. Please contact Ai-Thinker if need to use. SPI0_MISO/SD_CLK/external Flash this pin is NC
13	DP	PA29/SPI1_CLK/SD_CLK/FSDP
14	DM	PA28/SPI0_MISO/SD_CMD/FSDM
15	GND	Ground
16	PA26	SPI0_CLK/SD_D2
17	LOG_TX	UART_LOG_TXD, firmware download TX pin, Please do not external pull down, which will enter the Flash download mode.
18	PA27	SPI0_MOSI/SD_D3
19	PA30	SPI1_MOSI/SWD_CLK/SD_D0, default function is SWD DATA, IC can be configured as PA31
20	PA31	SPI1_MISO/SWD_DAT/SD_D1, fefault function is SWD DATA, IC can be configured as PA31
21	PB30/RXD	UART1_RXD, Do not external pull down, external pull down will enter Load OTP settings
22	PB31/TXD	UART1_TXD, Do not external pull down, external pull down will enter test mode
23	ANT	ANT pin. Hanging over when not in use, ANT pin do not cross the surface of the bottom plate.

Note: 1. When the LOG _ TX power is low, the module enters the burning mode; when the power is high, the module starts normally and the internal pull up by default.

- 2. PA13 and PA16 are internally occupied in the external Flash versions. At this time, the two IO are not available, and the pins are suspended.
- 3. PB 30 / RXD Do not pull down externally, external pull down will enter Load OTP settings.
- 4. PB 31 / TXD Do not pull down externally, the external pull down will enter the chip test mode.
- 5. The ANT pin is the antenna pin. When not in use, ANT pin do not cross the surface of the bottom plate.



5. Schematic diagram

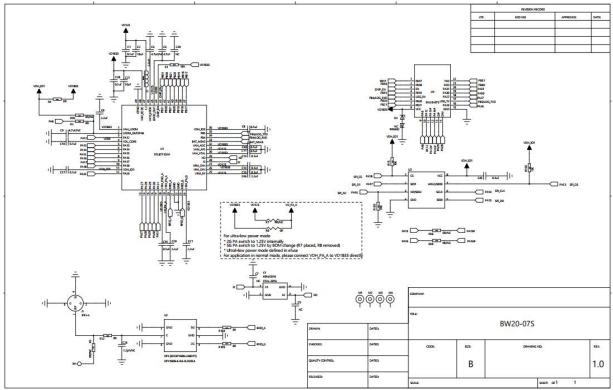


Figure 7 Schematic diagram



6. Design guide

6.1. Circuit guidance of application

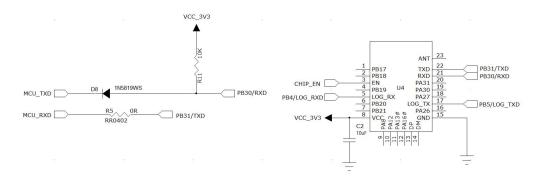


Figure 8 Application guidance circuit

Note:

■ LOG _ TX is the starting control pin in normal operating mode at high level and burning firmware mode at low level. Internal chip default high level.

6.2. Recommend PCB package size

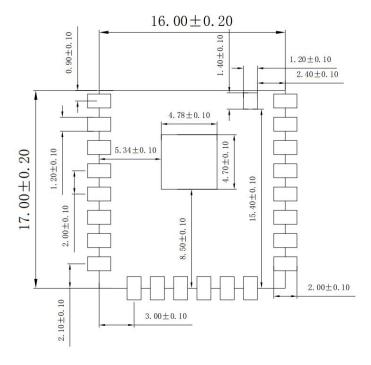


Figure PRecommend PCB pakage size (TOP view)

Note: when ANT pin are not used, the module package is not reflected; for layout ANT pin do not cross the surface of the bottom plate.



6.3. Antenna layout requirements

- The module requires use by an external antenna.
- In order to satisfy the performance of the antenna, metal parts are prohibited around the antenna away from high frequency devices.

6.4. Power supply

- Recommended 3.3V voltage, peak current above 500 mA.
- It is recommended to use LDO; if DC-DC, ripple control within 30 mV.
- The DC-DC power supply circuit suggests to reserve the position of the dynamic response capacitor, which can optimize the output ripple when the load change is large.
- 3.3V power interface, it is recommended to add ESD devices.
- If the power supply is boosted from 1.5V to 3.0V for more than 15 ms, add the voltage reset IC or use the wide voltage version Flash.
- During the repeated up and down process, if the voltage cannot be less than 0.3V, the voltage reset IC must be increased.

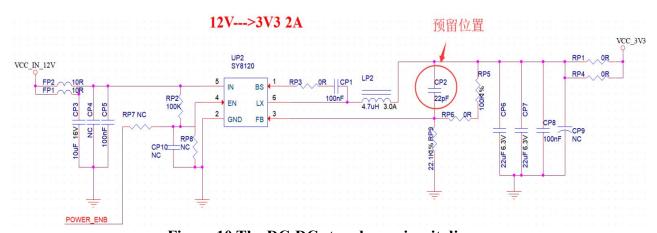


Figure 10 The DC-DC step-down circuit diagram

6.5. GPIO

- The periphery of the module introduces some IO ports and, if necessary, uses the recommended resistance of 10-100 ohms in series on the IO ports. This can suppress the overshoot and make the level on both sides more stable. For both EMI and ESD.
- Pull up and down of the special IO port, refer to the instructions of the specification, which will affect the startup configuration of the module.
- The IO port of the module is 3.3V. If the main control does not match the IO port level of



the module, the level conversion circuit should be added.

■ If the IO port is directly connected to the peripheral interface or terminals, it is recommended to reserve ESD devices at the IO port line near the terminal.

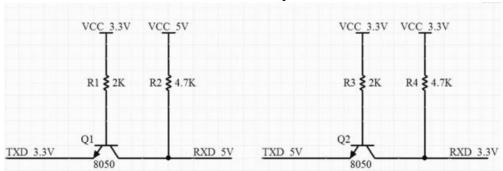


Figure 11 The level conversion circuit

7. Storage conditions

Products sealed in moisture-proof bags should be stored in a non-condensing atmosphere of <40 ° C /90%RH.

The module has a moisture sensitivity rating of MSL 3.

After the vacuum bag is opened, it must be used within 168 hours at 25±5°C/60%RH, otherwise it needs to be baked before it can be put on line again.

8. Reflow welding curve diagram

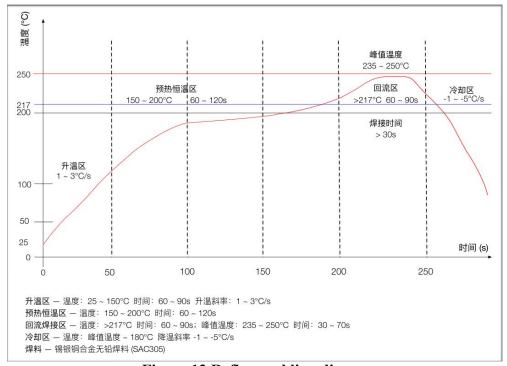


Figure 12 Reflow welding diagram



9. Product packaging information

BW20-07S module module was packaged in a tape, 800pcs/reel. As shown in the below image:



Figure 13 Package and packing diagram

10.Contact us

Ai-Thinker official website Office forum Develop DOCS

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